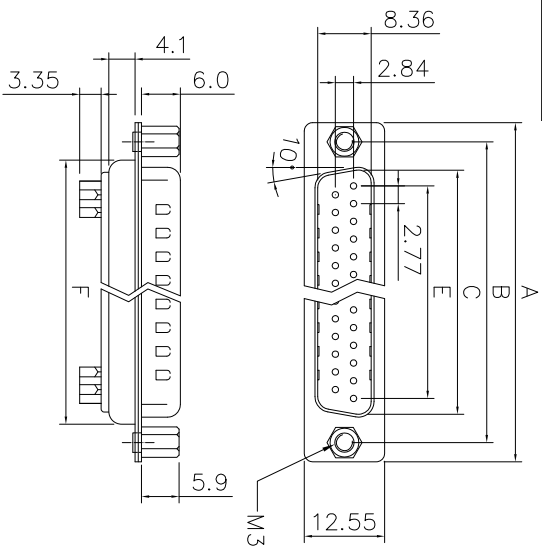
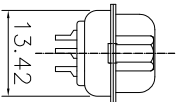
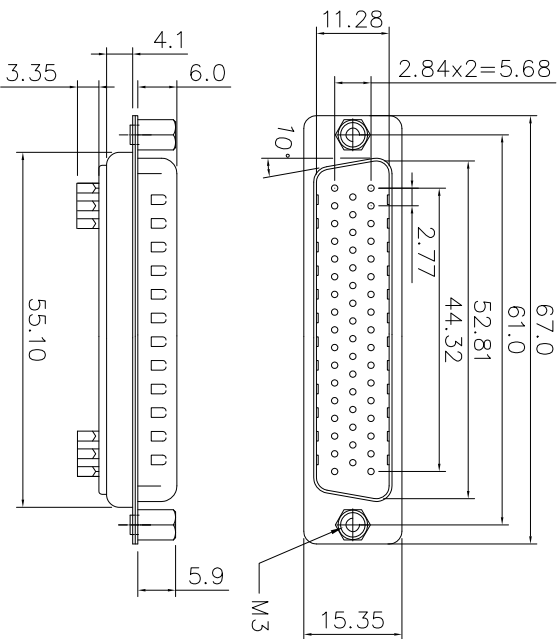


Positions	A	B	C	E	F
9	30.81	24.99	16.92	11.08	19.20
15	39.20	33.30	25.25	19.39	27.70
25	53.04	47.04	38.96	33.24	41.10
37	69.40	63.50	55.42	49.86	57.30



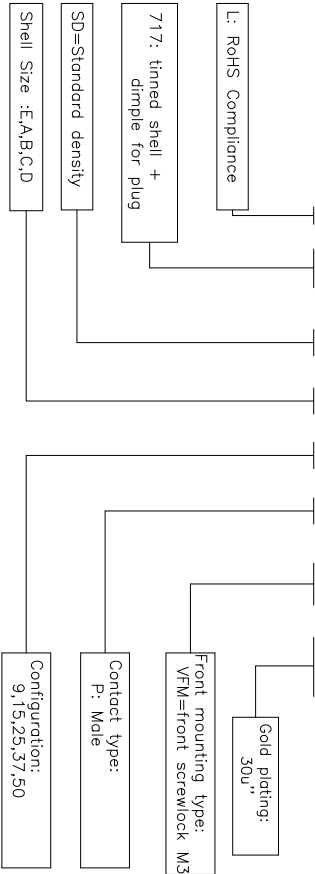
REVISIONS			
SYM	ECN	DESCRIPTION	DATE
1	HK--	First Release Drawing	Apr/30/2013
			IP

D-SUB TECHNICAL DATA

- SHELL : Steel, 100u" min tin over 50u" min nickel
over 50u" min Copper
- BODY : Glass-Filled Thermoplastic PBT,UL94V-0
- CONTACTS : Copper alloy
50u" gold over 50u" min nickel on mating area.
100u" min tin over 50u" min nickel on solder area.
- SCREWLOCK : Brass, Nickel Plated
- ELECTRICAL : Voltage rating 250 VAC/Rms 60Hz
Current rating 3A.
Withstanding Voltage >1000 VAC/Rms 60Hz for one minute
Insulation resistance >1000 M Ohms
Contact resistance 20 mOhms Max.
- MARKING : Amphenol---(Series No.)
Commercial reference
Manufacturing date

PRODUCT CODE

L 717 SD X XX P VFM C309



UNLESS OTHERWISE SPECIFIED			
TOLERANCES		APPROVAL	DATE
U.S.	METRIC	DRAWN	Bydly
.X +/-. .XX +/-. .XXX +/-. FRACTIONS +/-. ANGLES +/-. 5°	0.50 0.30 0.20	CHECKED	Visentel
FOR MATERIALS AND FINISHES SEE NOTES REMOVE SHARP EDGES		APR/30/2013	
DIMENSIONS		DRAWING FILE :	
U-S	INCHES	ANGLE OF PROJECTION	
METRIC	MM		
SIZE		TITLE	
A4	L717SDXXXPVFMC309	D-sub,solder cup, 30u"	
SCALE		REV.	
NONE	SHEET 1 OF 1	1	